



ISDN S₀ Compact SMD Interface Modules

Features

- excellent output characteristics ensure compliance with CCITT.I.430 pulse waveform template when used with recommended IC pairing
- SMD modules are designed for pick and place compatability
- excellent and consistent balance between windings
- modular design maximizes suppression effectivity and transmission properties
- compact module eliminates three components reducing assembly and storage cost
- full compatibility with all common IC's
- operating temperature: 0 to 70°C



Electrical Specifications @ 25°C

Turns Ratio: **Bold** = IC side windings

Compact SMD Modules comply with Basic Insulation Level EN60950, UL1950 and UL1459

Part Number	L _P (mH Min)	Turns Ratio	L _L (μH Max)	I _{DC} (mA)	C _C (pF Max)	R _{CU} P (Ohms)	R _{CU} S (Ohms)	V _P (Vrms)	Schematic
MSJ-400A-XXX	30	1:1:1:1	10	4	150	1.7	2.0	1500	A
MSJ-403A-XXX	30	1:1:2:2	10	4	150	1.7	4.0	1500	A
MSJ-405A-XXX	30	1:1: 2.5:2.5	10	4	150	1.7	4.6	1500	A
MAJ-400A-XXX	30	1:1:1:1	5	4	120	1.7	1.7	1500	A
MAJ-403A-XXX	30	1:1:2:2	5	4	120	1.7	3.4	1500	A
MAJ-405A-XXX	30	1:1: 2.5:2.5	5	4	120	1.9	4.4	1500	A

Common Mode Choke

Basic P/N + Suffix (Example: MSJ-403A-470)	L _N (μH)	R _{CU} (Ohms)
-000	No Choke	
-470	47	0.5
-101	100	0.7
-501	500	0.5
-502	5000	2.0

Test Conditions:

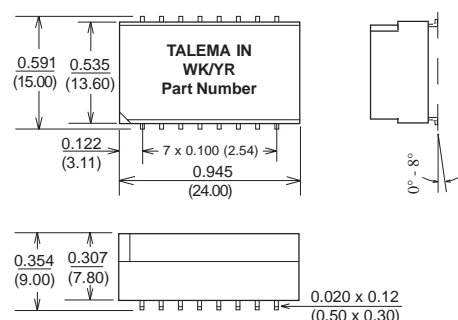
Inductance and coupling capacitance: 10kHz, 100mV

Common Mode Choke Inductance: 100kHz, 20mV

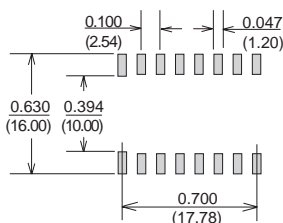
Leakage Inductance: 100kHz, 100mV

Standard Packaging: Tape and Reel

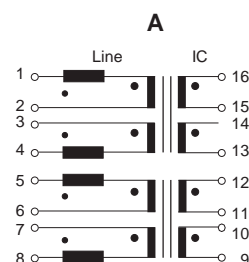
MSJ Module



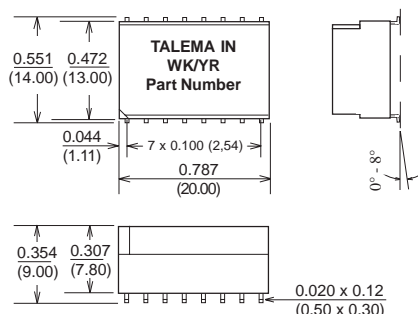
Suggested Pad Layout MSJ



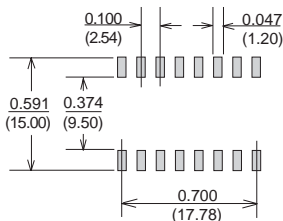
Schematic



MAJ Compact Chip Module



MAJ



Surface Coplanarity will be 0.004(0.10) maximum

Dimensions: Inches (Millimeters)

Tolerance: ±0.010 (0.25) unless specified otherwise

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